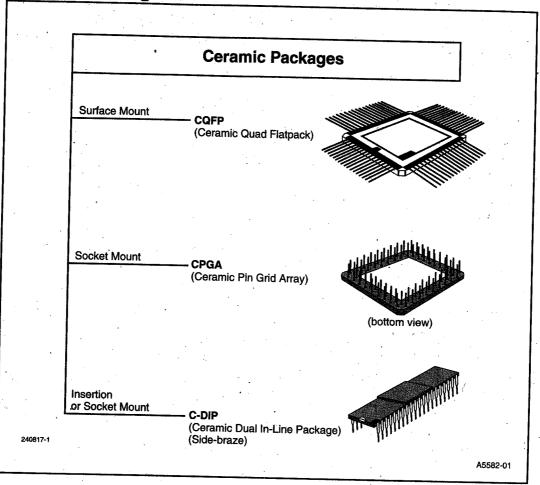
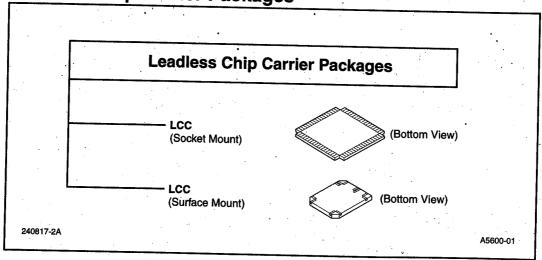
## 1.3.1 Ceramic Packages



## 1.3.2 Leadless Chip Carrier Packages

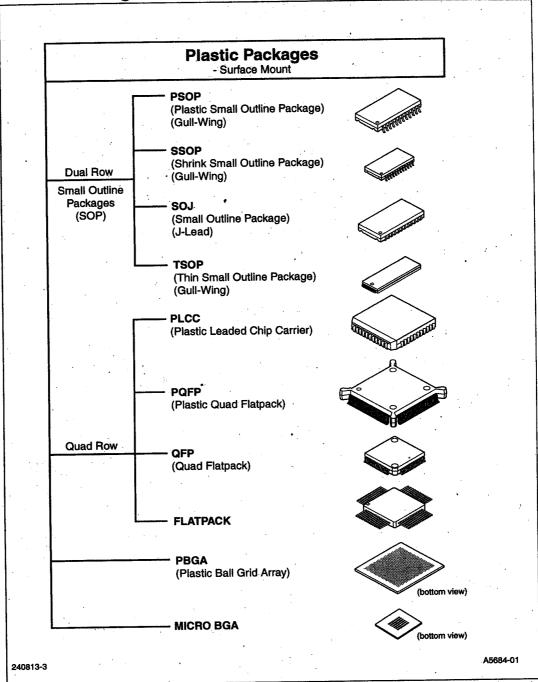


## Glass-Sealed Packages Glass-Sealed Packages CERDIP (Ceramic Dual In-Line Package) (Insertion Mount; UV Window)

240817-2

# Modules SIMM (Single In-Line Leadless Memory Module) SiP (Single In-Line Leaded Memory Module) (Top View) (Top View) A5686-01

## 13.5 Plastic Packages - Surface Mount



### 1.3.6 Plastic Packages - Insertion Mount/Socket Mount

